Bluetooth® low energy Module Bluetooth® 5.0 low energy EYSHCNZWZ

Data Report

By purchase of any products described in this document, the customer is deemed to understand and accept contents of this document.

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Revision History

30-Jun.-2017 > Ver.1.0 Release

25-Sep.-2017 > Ver.1.1 Update

11-May -2018 > Ver.1.2 Update

27-Feb. -2019 > Ver.1.3 Update

6-Jun. -2019 > Ver.1.4 Update

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Control No.		Control name
HD-AG-A160260	(1/5)	General Items

1. Scope

This specification ("Specification") applies to the hybrid IC "EYSHCNZWZ", a **Bluetooth**® 5.0 low energy module ("Product") manufactured by TAIYO YUDEN Co., Ltd. ("TAIYO YUDEN")

2. Description

a) User Code : EYSHCNZWZ Type : EYSHCN

> *User Code may be changed for mass production or other cases. Note: Please use the User Code (EYSHCNZWZ) to order this product

b) Chip: Nordic nRF52832 (512kB Flash, 64kB RAM)

c) Function: Radio frequency transceiver Module. Bluetooth®5.0 conformity.

d) Application : IoT devices, Health & Fitness Equipment, Sensor, Toys

e) Structure : Hybrid IC loaded with silicon monolithic semiconductor

Containment of hazardous substance in this Product

Can meet with RoHS compliance (Pb, Cd, Hg, Cr+6, PBB, PBDE)

f) Outline: 49-pin Land Grid Array

g) Marking: Part Number, Lot Number, Japan ID, FCC ID, ISED Number and manufacturer on

Shielding Case

h) Country of origin: Japan

i) Packaging: Packaging method: Tape & reel + aluminum moisture barrier bag

Packaging unit: 1000

*It might be provided as tray at sample stage.

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Control No.		Control name
HD-AG-A160260	(2/5)	General Items

i) Notes:

a. Limitation of Warranty

- 1) TAIYO YUDEN provides warranties only if the Product is operated under the condition set forth in this Specification. Please note that TAIYO YUDEN shall not be liable for any defect and/or malfunction arising from use of the Product under the terms and conditions other than the operating conditions hereof. In addition when this Product is used under environmental conditions such as over voltage which is not guaranteed, it may be destroyed in short mode. To ensure the security of customer's product, please add an extra fuse or/and a protection circuit for over voltage.
- 2) This Product is designed for use in products which comply with Bluetooth® Specifications. TAIYO YUDEN disclaims and is not responsible for any liability concerning infringement by this Product under any intellectual property right owned by third party in case the customer uses this Product in any product which does not comply with Bluetooth® Specifications (the "non-complying products"). Furthermore, TAIYO YUDEN warrants only that this Product complies with this Specification and does not grant any other warranty including warranty for application of the non-complying products.
- 3) In some cases, TAIYO YUDEN may use replacements as component parts of Products. Such replacement shall apply only to component part of Products, which TAIYO YUDEN deems it possible to replace or substitute according to (i) Scope of Warranty provided in this specification (e.g. Electric Characteristics, Outline, dimension, Conditions of Use, Reliability Tests, Official Standard (Type Approvals etc.)) and (ii) Quality of Products. TAIYO YUDEN also ensures traceability of such replacement on production lot basis.

b. Instruction for Use (CAUTION)

- 1) Because Product is not designed for radiation durability, please refrain from exposing Product to radiation in the use.
- 2) Communication between this Product and other might not be established nor maintained depending upon radio environment or operating condition of this Product and other products with wireless technology.
- 3) This Product operates in the unlicensed ISM band at 2.4GHz. In case this Product is used around the other wireless devices which operate in same frequency band of this Product, there is a possibility that interference occurs between this Product and such other devices. If such interference occurs, please stop the operation of other devices or relocate this Product before using this Product or do not use this Product around the other wireless devices.
- 4) This Product mentioned in this Specification is manufactured for use in Health & Fitness Equipment, Sensor, Toys. Before using this Product in any special equipment (such as medical equipment, space equipment, air craft, disaster prevention equipment), where higher safety and reliability are duly required, the applicability and suitability of this Product must be fully evaluated by the customer at its sole risk to ensure correct and safety operation of those special equipments. Also, evaluation of the safety function of this Product even for use in general electronics equipment shall be thoroughly made and when necessary, a protective circuit shall be added in design stage, all at the customer's sole risk.

TAIYO YUDEN CO., LTD.

Control No.		Control name
HD-AG-A160260	(3/5)	General Items

5) Japan Regulatory Information

This module is approved with the specific antenna on this module.

a) Please ensure that your product can bear a label with the following information. If the product is so small that it is not practicable to place the label, please place it in the instruction manual and package.

This product installs a radio system which has been approved as a radio station in a low power data communication system based on the Radio Law.

EYSHCN: 001-A10745

6) Canada Regulatory Information

- a) This device complies with Industry Canada's applicable license-exempt RSSs. Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.
 - Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : 1) l'appareil ne doit pas produire de brouillage; 2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.
- b) This product is certified as type of the portable device with Industry Canada Rules. To maintain compliance with RF Exposure requirement, please use within specification of this product.

Ce produit est certifié comme type de l'appareil portable avec Industrie Règles de Canada. Pour maintenir l'acquiescement avec exigence Exposition de RF, veuillez utiliser dans spécification de ce produit.

- IC: 4389B-EYSHCN
- c) Please notify certified ID by either one of the following method on your product. Specifiez ID certifiée dans votre produit par une de méthode suivante.
 - -Contains Transmitter module IC: 4389B-EYSHCN
 - -Contains IC: 4389B-EYSHCN

7) FCC Regulatory Information

- a) This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.
- b) Please notify certified ID by either one of the following method on your product.
 - -Contains Transmitter Module FCC ID: RYYEYSHCN
 - -Contains FCC ID: RYYEYSHCN
- c) CAUTION: changes or modifications not expressly approved by the party responsible for compliance could void the use's authority to operate the equipment.

TAIYO YUDEN CO., LTD.

Control No.		Control name
HD-AG-A160260	(4/5)	General Items

- d) This product is certified as type of the portable device with FCC Rules. To maintain compliance with RF Exposure requirement, please use within specification of this product.
- e) The antenna used for this transmitter must not be co-located or operating in conjunction with any other antenna or transmitter.
- f) This module can change the output power depending on the circumstances by the application software which is developed by module installer. Any end user cannot change the output power.

8) CE Regulatory Information

a) This module complies with the standards below which are required by RED (2014/53/EU). All of the test reports are provided by TAIYO YUDEN.

Radio: ETSI EN 300 328 V2.1.1 (2016-11) EMC: ETSI EN 301 489-17 V3.1.1 (2017-02)

ETSI EN 301 489-1 V2.1.1 (2017-02)

Safety: EN 62368-1:2014+A11:2017

b) When your end product installs this module, it is required to proceed additional certification processes before placing it on the market in EU member states to make your products fully complied with relative EU standards. The test report of conducted measurement portion of this module can be utilized for the certification processes of your end product.

c. Term of Support

- 1) In the case that customer requests TAIYO YUDEN to customize the hardware of this Product in order to meet such customer's specific needs, TAIYO YUDEN will make commercially reasonable effort to modify such hardware or software at customer's expense; provide however, the customer is kindly requested to agrees it doesn't mean that TAIYO YUDEN has obligations to do so even in the case it is technically difficult for TAIYO YUDEN.
- 2) Any failure arising out of this Product will be examined by TAIYO YUDEN regardless of before or after mass production. Customer agrees that once such failure is turned out not to be responsible for TAIYO YUDEN after aforesaid examination, some of the technical support shall be conducted by TAIYO YUDEN at customer's expense; provided however, exact cost of this technical support can be agreed through the negotiation by the parties.
- 3) Do not alter hardware and/or software of this Product. Please note that TAIYO YUDEN shall not be liable for any problem if it is caused by customer's alteration of Hardware without Taiyo Yuden's prior approvals.
- 4) TAIYO YUDEN does not guarantee functions and performances which depend on the customer's firmware. TAIYO YUDEN does not assume liabilities for defects and failures (i) in functions, performances and quality of the Customer's product incorporating the Products and (ii) which may occur as the Product is incorporated in the Customer's product.

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Control No.		Control name
HD-AG-A160260	(5/5)	General Items

d. Caution for Export Control

This Product may be subject to governmental approvals, consents, licenses, authorizations, declarations, filings, and registrations for export or re-export of the Product, required by Japanese Foreign Exchange and Foreign Trade Law (including related laws and regulations) and/or any other country's applicable laws or regulations related to export control.

In case you will export or re-export this Product, you are strongly recommended to check and confirm, before exporting or re-exporting, necessary procedures for export or re-export of this Product which is required by applicable laws and regulations, and if necessary, you have to obtain necessary and appropriate approvals or licenses from governmental authority at your own risk and expense.

e. Term of Warranty

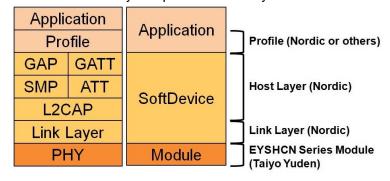
TAIYO YUDEN warrants only that this Product is in conformity with this Specification for one year after purchase and shall in no event give any other warranty.

f. Items of the Specification

- 1) Any question arising from the Specification shall be solved in good faith through mutual discussion by the parties hereof.
- 2) The language of this "General items" is Japanese and this "General items" shall be interpreted by Japanese Any copies of translation is a reference purpose only and is not binding on both parties hereto.

g. Special note

- Taiyo Yuden writes firmware for and fixed SoftDevice (s132_nrf52_5.0.0_softdevice.hex) to this product. Customer writes firmware that is match the customer applications including SoftDevice at the customer's own responsibility.
- 2) The Electrical Characteristics defined in this Specification are of the module with above Firmware (s132_nrf52_5.0.0_softdevice.hex). If other firmware developed by Customer is installed, the characteristics may differ from the defined value in the Electrical Characteristics. Bluetooth qualification and radio type approval may become invalid.
- 3) EYSHCN series module is qualified as PHY only with Component category by Bluetooth SIG. The QDID of this module is 97470. The final product needs to get qualification as End product combining with PHY (module), SoftDevice and Profile before selling the product. The combination of Link and Host layer is differ with SoftDevice. Please refer to following combination and consult with your qualification body and BQC.



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Control No.		Control name
HD-AM-A160260 (1	/1)	Absolute maximum ratings

Absolute maximum ratings

Symbol	Parameter	Min.	Max.	Units
VCC_NRF		-0.3	+3.9	V
GND			0	V
VIO, VCC_NRF≤3.6V		-0.3	VCC_NRF+ 0.3	V
VIO, VCC_NRF>3.6V		-0.3	+3.9	V
Storage temperature		-40	+85	Deg-C
MSL	Moisture Sensitivity Level		3	
ESD HBM	Human Body Model		1	kV
ESD MM	Machine Model		100	V
Endurance	Flash Memory Endurance	10000		write/erase cycles
Retention	Flash Memory Retention	10 years		At 40 deg-C
Number of times a 512 byte block can be written between erase cycles	32bit writes		181	times

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Control No.		Control name
HD-AE-A160260	(1/3)	Electrical characteristics

Electrical characteristics

Recommendation operating range

Symbol	Parameter	Min.	Тур.	Max.	Units
VCC_NRF	Supply voltage, normal mode	1.7	3.0	3.6	V
tR_VCC_NRF	Supply rise time (0V to 1.7V)*1			60	ms
TA	Operation temperature*2	-40	25	85	Deg-C

^{*1} The on-chip power-on reset circuitry may not function properly for rise times outside the specified interval. Also after power off, it must start up from below 0.3V. The on-chip power-on reset circuitry may not function properly.

DC Specifications

The Specification applies for Topr.= 25 degrees C, VCC_NRF = 3.0V

Symbol	Parameter (condition)	Min.	Тур.	Max.	Units
VIH	Input high voltage	0.7 VCC_NRF		VCC_NRF	V
VIL	Input low voltage	GND		0.3 VCC_NRF	V
VOH	Output high voltage (high drive 5 mA)	VCC_NRF-0.4		VCC_NRF	V
VOL	Output low voltage (high drive 5 mA)	GND		GND+0.4	V
RPU	Pull-up resistance	11	13	16	Kohm
RPD	Pull-down resistance	11	13	16	Kohm
ITX,+4dBm ,DCDC	TX only run current (DCDC, 3V) PRF=+4 dBm		7.5		mA
ITX,+4dBm	TX only run current PRF=+4 dBm		16.6		mA
IRX,1M, DCDC	RX only run current (DCDC, 3V) 1Msps BLE		5.4		mA
IRX,1M	RX only run current 1Msps BLE		11.7		mA
IRX,2M, DCDC	RX only run current (DCDC, 3V) 2Msps BLE		5.8		mA
IRX,2M	RX only run current 2Msps BLE		12.9		mA
IOFF	Current in SYSTEM-OFF, no RAM retention		0.3		uA
ION	SYSTEM-ON base current		1.2		uA
IRAM	Additional RAM retention current per 4KB RAM block		20		nA

^{*2} ANT specification requires +/-50ppm accuracy for 32.768kHz clock. The internal 32.768kHz crystal does not meet to +/-50ppm over the whole recommended operation temperature range.

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Control No.		Control name
HD-AE-A160260	(2/3)	Electrical characteristics

RF Specifications

Symbol	Description	Min.	Тур.	Max.	Units
Fop	Operating frequencies	2402	2402 2480 M		MHz
PLLchsp	PLL channel spacing	1 MH		MHz	
DfBLE1M	Frequency deviation @ BLE 1Msps		+/-250		kHz
DfBLE2M	Frequency deviation @ BLE 2Msps		+/-500		kHz
PRF	Maximum output power		4	6	dBm
PRFC	RF power control range	24 dB		dB	
PRFCR	RF power accuracy	+/-4 dB		dB	
PRF1	1st Adjacent Channel Transmit Power 1 MHz	-25 dBc		dBc	
PRF2	2nd Adjacent Channel Transmit Power 2 MHz	-50 dBc		dBc	
PRXMAX	Maximum received signal strength at < 0.1% PER		0 dBm		dBm
DOENIC IT AM DIE	Receiver sensitivity 1Msps BLE Ideal transmitter		-96		dBm
PSENS,IT,1M,BLE	<=37bytes (0.1% BER)		-90		иын
PSENS,IT,2M,BLE	Receiver sensitivity 2Msps BLE Ideal transmitter		-93		dBm
I SENS, II, ZIVI, BLE	Packet length<=37bytes		-90		ubili

Many documents of nRF52832, such as product specification and the errata, can be found at the link below. Please be sure to check these latest documents when using our module.

nRF52832_Product Specification

https://infocenter.nordicsemi.com/topic/struct_nrf52/struct/nrf52832_ps.html?cp=3_1_0

nRF52832_Errata

https://infocenter.nordicsemi.com/topic/struct_nrf52/struct/nrf52832_errata.html?cp=3_1_1

S132_SoftDevice Specification

https://infocenter.nordicsemi.com/topic/sds_s132/SDS/s1xx/s130.html?cp=3_4_1_0

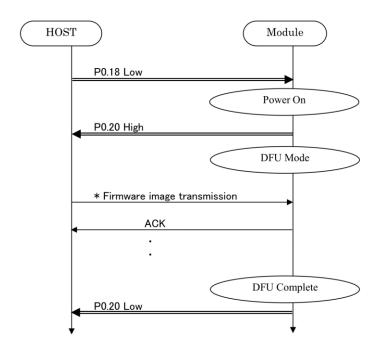
For more information

https://infocenter.nordicsemi.com/index.jsp

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Control No.		Control name
HD-AE-A160260	(3/3)	Electrical characteristics

DFU Specifications



UARI		
Baud rat	e : 38400 bps	UART PIN :
Data:8	bit	RX : P0.08
Parity : r	one	TX : P0.06
Stop:1	bit	CTS: P0.07
Hardware	e flow control : Enable	RTS : P0.05

* see Nordic Infocenter

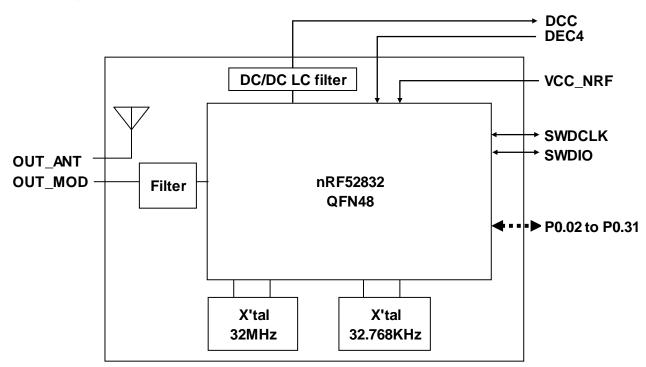
[Nordic Infocenter] http://infocenter.nordicsemi.com/index.jsp Software Development Kit > nRF5 SDK > nRF5 SDK v14.0.0 > Examples > DFU bootloader examples > Serial Secure DFU Bootloader

How to obtain Private (signing) key is attached to evaluation board (EBSHxNZWZ) or evaluation kit (EKSHxNZWZ).

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Control No.		Control name
HD-MC-A160260 (1	1/3)	Circuit Schematic

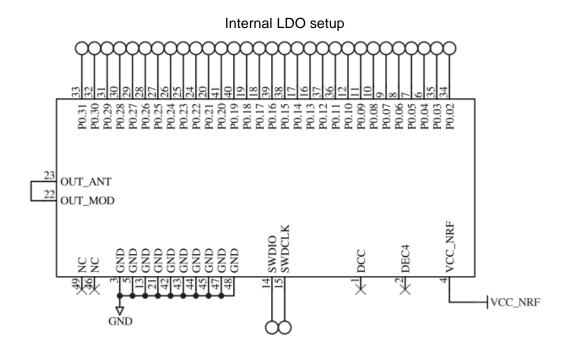
Block Diagram

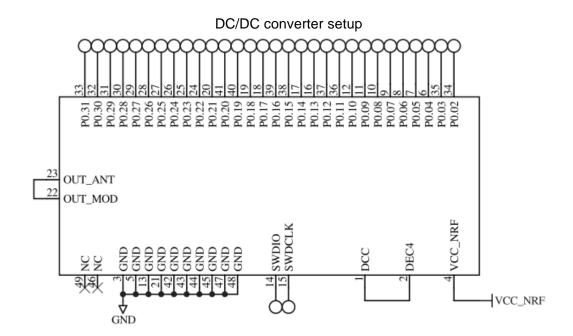


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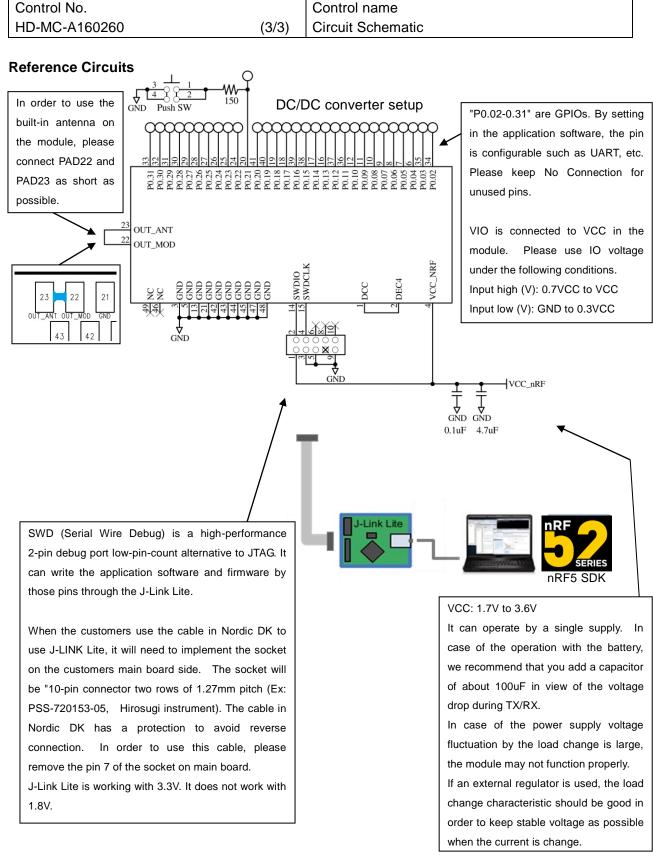
Control No.		Control name
HD-MC-A160260	(2/3)	Circuit Schematic

Sample circuits



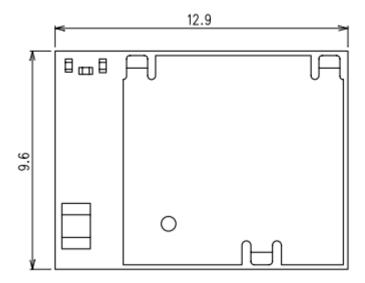


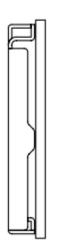
TAIYO YUDEN CO., LTD.

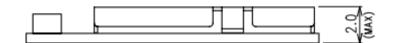


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Control No.		Control name
HD-AD-A160260	(1/3)	Outline/Appearance

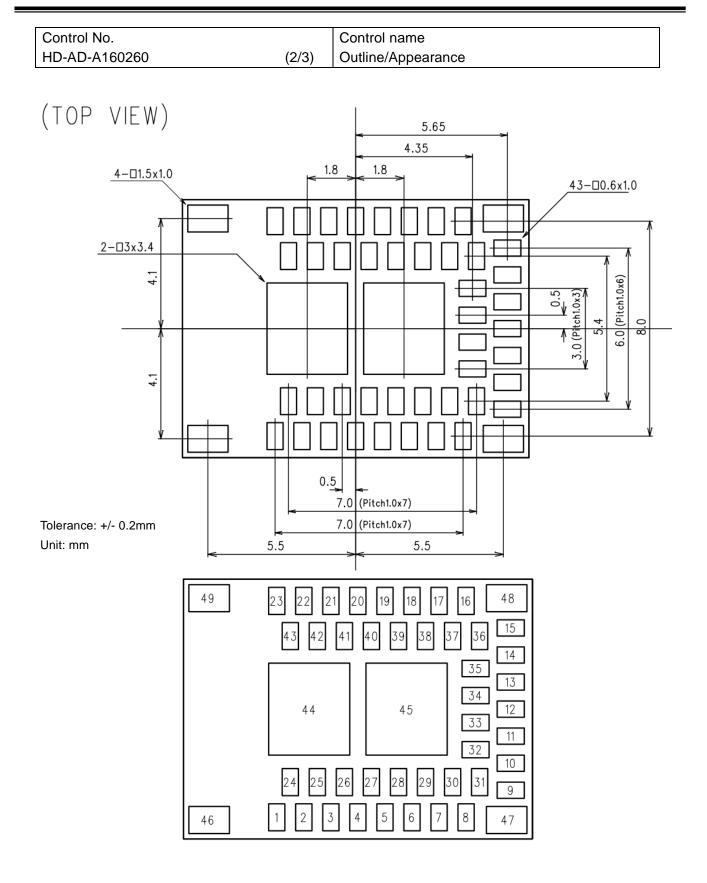






Tolerance: +/- 0.2mm

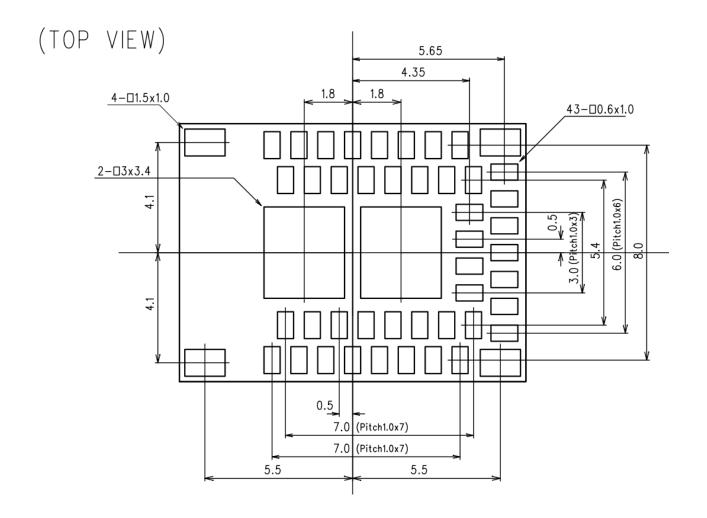
Unit: (mm)



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Control No.	Control name
HD-AD-A160260 (3/3)	Outline/Appearance

LAND PATTERN EXAMPLE



Recommended metal mask for solder printing

Pad size	Mask opening
Signal pad 43 – 0.6 x 1.0 mm	0.5 x 0.9 mm
Corner pad 4 – 1.5 x 1.0 mm	1.0 x 0.7 mm
Center pad 2 – 3.0 x 3.4 mm	2.6 x 3.0 mm

The center of each mask opening is same as the pad center.

The metal mask thickness: t=0.1mm

The solder volume should be same by changing the mask opening if different metal mask thickness is used.

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Control No.		Control name
HD-BA-A160260	(1/2)	Pin Layout

Pin Descriptions

DCC	Pin	Pin name	Pin function	Description		
DEC4	1	DCC	Power	DC/DC converter output pin (built-in LC for DC/DC).		
Input from DC/DC converter. Output from 1.3 V LDO.	2	DEC4	Dower	1V3 regulator supply decoupling.		
4 VCC_NRF Power Power Power supply pin. 5 GND Ground Ground pin. (0 V) 6 P0.04 Digital I/O General purpose I/O pin. 7 P0.05 Digital I/O General purpose I/O pin. 8 P0.06 Digital I/O General purpose I/O pin. 8 P0.06 Digital I/O General purpose I/O pin. 9 P0.07 Digital I/O General purpose I/O pin. 10 P0.08 Digital I/O General purpose I/O pin. 11 NFC1 NFC input NFC antenna connection. 12 P0.09 Digital I/O General purpose I/O pin. 13 GND Ground Ground Pin. (0 V) 14 SWDIO Digital I/O Serial Wire Debug I/O for debug and programming 15 SWDCLK Digital I/O General purpose I/O pin. 16 P0.13 Digital I/O General purpose I/O pin. 17 P0.14 TRACEDATA[3] Digital I/O General purpose I/O pin. 18 P0.17 Digital I/O General purpose I/O pin. 19 P0.21 RESET Digital I/O General purpose I/O pin 19 Ground Ground Ground General purpose I/O pin. 19 P0.21 Ceneral purpose I/O pin 19 General purpose I/O pin 19 General purpose I/O pin 19 P0.21 Ceneral purpose I/O pin 19 General purpose I/O pin 19 General purpose I/O pin 19 Ceneral purpose I/O pin 19 P0.21 Ceneral purpose I/O pin 20 P0.21 Ceneral purpose I/O pin 20 P0.21 Ceneral purpose I/O pin 21 Ceneral purpose I/O pin 22 OLIT MOD REFIN/Out	2	DEC4	Power	Input from DC/DC converter. Output from 1.3 V LDO.		
Solition	3	GND	Ground	Ground pin. (0 V)		
6 P0.04 AlN2 Analog input SAADC/COMP/LPCOMP input. 7 P0.05 Digital I/O General purpose I/O pin. 8 P0.06 Digital I/O General purpose I/O pin. 8 P0.06 Digital I/O General purpose I/O pin. 9 P0.07 Digital I/O General purpose I/O pin. 10 P0.08 Digital I/O General purpose I/O pin. 11 NFC1 NFC input NFC antenna connection. 12 NFC2 NFC input NFC antenna connection. 13 GND Ground Ground pin. (0 V) 14 SWDIO Digital I/O Serial Wire Debug I/O pin. 15 SWDCLK Digital I/O General purpose I/O pin. 16 P0.13 Digital I/O General purpose I/O pin. 17 P0.14 TRACEDATA[3] Digital I/O General purpose I/O pin. 18 P0.17 Digital I/O General purpose I/O pin. 19 P0.18 TRACEDATA[0] Digital I/O General purpose I/O pin 10 P0.21 RESET Digital I/O General purpose I/O pin 11 P0.11 RESET Digital I/O General purpose I/O pin 12 P0.11 RESET Digital I/O General purpose I/O pin 13 GND Ground Ground Groundpin. (0 V) 14 SWDIO Digital I/O General purpose I/O pin. 15 Configurable as system RESET pin. (Factory default : RESET) 16 GND Ground Ground pin. (0 V)	4	VCC_NRF	Power	Power supply pin.		
AIN2 Analog input SAADC/COMP/LPCOMP input. P0.05 Digital I/O General purpose I/O pin. AlN3 Analog input SAADC/COMP/LPCOMP input. P0.06 Digital I/O General purpose I/O pin. P0.07 Digital I/O General purpose I/O pin. P0.08 Digital I/O General purpose I/O pin. NFC1 NFC input NFC antenna connection. P0.09 Digital I/O General purpose I/O pin. NFC2 NFC input NFC antenna connection. P0.10 Digital I/O General purpose I/O pin. SWDIO Digital I/O General purpose I/O pin. SWDIO Digital I/O General purpose I/O pin. SWDCLK Digital input Serial Wire Debug I/O for debug and programming Serial Wire Debug I/O for debug and programming General purpose I/O pin. P0.13 Digital I/O General purpose I/O pin. P0.14 P0.13 Digital I/O General purpose I/O pin. Trace port output. P0.17 Digital I/O General purpose I/O pin. Trace port output. P0.18 Digital I/O General purpose I/O pin Trace port output. P0.21 RESET Digital I/O General purpose I/O pin Configurable as system RESET pin. (Factory default : RESET) QUIT MOD REIN/Out	5	GND	Ground	Ground pin. (0 V)		
AlN2 Analog input SAADC/COMP/LPCOMP input. P0.05 AlN3 Analog input SAADC/COMP/LPCOMP input. B P0.06 Digital I/O General purpose I/O pin. P0.07 Digital I/O General purpose I/O pin. P0.08 Digital I/O General purpose I/O pin. NFC1 NFC input NFC antenna connection. P0.09 Digital I/O General purpose I/O pin. NFC2 NFC input NFC antenna connection. P0.10 Digital I/O General purpose I/O pin. SWDIO Digital I/O General purpose I/O pin. SWDIO Digital I/O Serial Wire Debug I/O for debug and programming Serial Wire Debug clock input for debug and programming Serial Wire Debug clock input for debug and programming P0.13 Digital I/O General purpose I/O pin. P0.14 TRACEDATA[3] Trace port output. P0.17 Digital I/O General purpose I/O pin Trace port output. P0.18 Digital I/O General purpose I/O pin Trace port output. General purpose I/O pin Trace port output. General purpose I/O pin Configurable as system RESET pin. (Factory default : RESET) QUIT MOD REIN/Out	6	P0.04	Digital I/O	General purpose I/O pin.		
AlN3 Analog input SAADC/COMP/LPCOMP input. Po.06 Digital I/O General purpose I/O pin.	O	AIN2	Analog input	SAADC/COMP/LPCOMP input.		
AlN3 Analog input SAADC/COMP/LPCOMP input. 8 P0.06 Digital I/O General purpose I/O pin. 9 P0.07 Digital I/O General purpose I/O pin. 10 P0.08 Digital I/O General purpose I/O pin. 11 NFC1 NFC input NFC antenna connection. 12 P0.09 NFC input NFC antenna connection. 13 GND Ground Ground pin. (0 V) 14 SWDIO Digital I/O Serial Wire Debug I/O for debug and programming 15 SWDCLK Digital input Serial Wire Debug I/O for debug and programming 16 P0.13 Digital I/O General purpose I/O pin. 17 P0.14 TRACEDATA[3] Digital I/O General purpose I/O pin. 18 P0.17 Digital I/O General purpose I/O pin. 19 P0.18 TRACEDATA[0] General purpose I/O pin 19 P0.21 RESET Digital I/O General purpose I/O pin 10 General purpose I/O pin 11 Configurable as system RESET pin. (Factory default : RESET) 21 GND Ground Ground pin. (0 V) RE In/Out RE In/Out RE In/Out RE In/Out It should be connected to Pin 23 OUT_ANT	7	P0.05	Digital I/O	General purpose I/O pin.		
9 P0.07 Digital I/O General purpose I/O pin. 10 P0.08 Digital I/O General purpose I/O pin. 11 NFC1 NFC input NFC antenna connection. 12 P0.09 Digital I/O General purpose I/O pin. 13 NFC2 NFC input NFC antenna connection. 14 SWDIO Digital I/O General purpose I/O pin. 15 SWDCLK Digital I/O Serial Wire Debug I/O for debug and programming 16 P0.13 Digital I/O General purpose I/O pin. 17 P0.14 Digital I/O General purpose I/O pin. 18 P0.17 Digital I/O General purpose I/O pin. 19 P0.18 Digital I/O General purpose I/O pin 19 P0.21 RESET Digital I/O General purpose I/O pin 19 Configurable as system RESET pin. 19 Ground Ground Ground pin. (0 V) 20 OLIT MOD RE In/Out	1	AIN3	Analog input	SAADC/COMP/LPCOMP input.		
10 P0.08 Digital I/O General purpose I/O pin. NFC1 NFC input NFC antenna connection. P0.09 Digital I/O General purpose I/O pin. NFC2 NFC input NFC antenna connection. P0.10 Digital I/O General purpose I/O pin. SWDD Ground Ground pin. (0 V) SWDCLK Digital I/O Serial Wire Debug I/O for debug and programming SWDCLK Digital input Serial Wire Debug clock input for debug and programming P0.13 Digital I/O General purpose I/O pin. P0.14 Digital I/O General purpose I/O pin. TRACEDATA[3] Trace port output. P0.18 P0.17 Digital I/O General purpose I/O pin P0.18 Digital I/O General purpose I/O pin Trace port output. P0.21 General purpose I/O pin Configurable as system RESET pin. (Factory default: RESET) 21 GND Ground Ground pin. (0 V) RE In/Out RE I/O pin. It should be connected to Pin 23 OUT_ANT	8	P0.06	Digital I/O	General purpose I/O pin.		
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Po.09 Digital I/O General purpose I/O pin.	10	P0.08	Digital I/O	General purpose I/O pin.		
P0.09 Digital I/O General purpose I/O pin.	11	NFC1	NFC input	NFC antenna connection.		
P0.10 Digital I/O General purpose I/O pin.	11	P0.09	Digital I/O	General purpose I/O pin.		
P0.10 Digital I/O General purpose I/O pin.	10	NFC2	NFC input	NFC antenna connection.		
SWDIO Digital I/O Serial Wire Debug I/O for debug and programming SWDCLK Digital input Serial Wire Debug clock input for debug and programming P0.13 Digital I/O General purpose I/O pin. P0.14 Digital I/O General purpose I/O pin. Trace port output. P0.17 Digital I/O General purpose I/O pin P0.18 Digital I/O General purpose I/O pin P0.18 Digital I/O General purpose I/O pin Trace port output. P0.21 General purpose I/O pin Configurable as system RESET pin. (Factory default : RESET) COLIT MOD RE In/Out RESIDOR OF TRACED ANT RESIDOR OF T	12	P0.10	Digital I/O	General purpose I/O pin.		
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Digital input Programming	14	SWDIO	Digital I/O	Serial Wire Debug I/O for debug and programming		
16 P0.13 Digital I/O General purpose I/O pin. 17 P0.14 Digital I/O General purpose I/O pin. 18 P0.17 Digital I/O General purpose I/O pin 19 P0.18 Digital I/O General purpose I/O pin TRACEDATA[0] Digital I/O General purpose I/O pin Trace port output. General purpose I/O pin Trace port output. General purpose I/O pin Trace port output. General purpose I/O pin Configurable as system RESET pin. (Factory default : RESET) 21 GND Ground Ground pin. (0 V) RE In/Out RE In/Out	15	SWDCLK	Digital input	·		
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(Factory default : RESET) 21 GND Ground Ground pin. (0 V) RF I/O pin. It should be connected to Pin 23 OUT_ANT	20		Digital I/O			
RF I/O pin. It should be connected to Pin 23 OUT_ANT		RESET		(Factory default : RESET)		
122 TOULMOD TREINOUT T	21	GND	Ground			
for normal operation.	22	OUT MOD	DE In/Out	RF I/O pin. It should be connected to Pin 23 OUT_ANT		
	22	OO1_MOD	KF In/Out	•		

Control No.		Control name
HD-BA-A160260	(2/2)	Pin Layout

Pin	Pin name	Pin function	Description
23	OUT_ANT	Antenna In/Out	Internal antenna. It should be connected to Pin 22 OUT_MOD for normal operation.
24	P0.22	Digital I/O	General purpose I/O pin.
25	P0.23	Digital I/O	General purpose I/O pin.
26	P0.24	Digital I/O	General purpose I/O pin.
27	P0.25	Digital I/O	General purpose I/O pin.
28	P0.26	Digital I/O	General purpose I/O pin.
29	P0.27	Digital I/O	General purpose I/O pin.
20	P0.28	Digital I/O	General purpose I/O pin.
30	AIN4	Analog input	SAADC/COMP/LPCOMP input.
24	P0.29	Digital I/O	General purpose I/O pin.
31	AIN5	Analog input	SAADC/COMP/LPCOMP input.
32	P0.30	Digital I/O	General purpose I/O pin.
32	AIN6	Analog input	SAADC/COMP/LPCOMP input.
33	P0.31	Digital I/O	General purpose I/O pin.
33	AIN7	Analog input	SAADC/COMP/LPCOMP input.
34	P0.02	Digital I/O	General purpose I/O pin.
	AIN0	Analog input	SAADC/COMP/LPCOMP input.
35	P0.03	Digital I/O	General purpose I/O pin.
	AIN1	Analog input	SAADC/COMP/LPCOMP input.
36	P0.11	Digital I/O	General purpose I/O pin.
37	P0.12	Digital I/O	General purpose I/O pin.
38	P0.15	Digital I/O	General purpose I/O pin.
30	TRACEDATA[2]	Digital 1/O	Trace port output.
39	P0.16	Digital I/O	General purpose I/O pin.
33	TRACEDATA[1]	Digital 1/O	Trace port output.
40	P0.19	Digital I/O	General purpose I/O pin.
41	P0.20	Digital I/O	General purpose I/O pin.
41	TRACECLK		Trace port clock output.
42 to 45	GND	Ground	Ground pin. (0 V)
46	NC	Not Connected	Isolated pad on PCB for mechanical stability.
47 to 48	GND	Ground	Ground pin (0 V)
49	NC	Not Connected	Isolated pad on PCB for mechanical stability.

TAIYO YUDEN CO., LTD.

Control No.		Control name
HQ-BA-537	1/2)	Handling Precaution

This specification describes desire and conditions especially for mounting.

Desire/Conditions

- (1) Environment conditions for use and storage
 - 1. Store the components in an environment of < <u>40deg-C/90%RH</u> if they are in a moisture barrier bag packed by TAIYO YUDEN.
 - 2. Keep the factory ambient conditions at < 30deg-C/60%RH.
 - 3. Store the components in an environment of < <u>25±5deg-C/10%RH</u> after the bag is opened. (The condition is also applied to a stay in the manufacture process).

(2) Conditions for handling of products

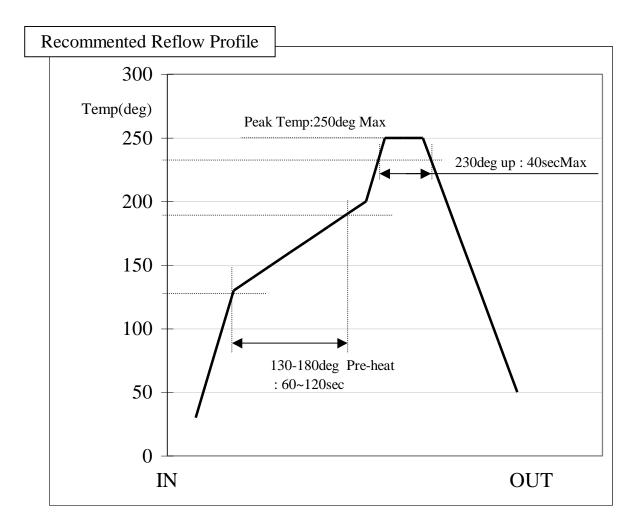
Make sure all of the moisture barrier bags have no holes, cracks or damages at receiving. If an abnormality is found on the bag, its moisture level must be checked in accordance with 2 in (2).

Refer to the label on the bag.

- 1. All of the surface mounting process (reflow process) must be completed <u>in 12 months</u> from the bag sea date.
- 2. Make sure humidity in the bag is less than **10%RH** immediately after open, using a humidity indicator card sealed with the components.
- 3. <u>All</u> of the surface mounting process (reflow process including rework process) must be completed in **168 hours** after the bag is opened (inclusive of any other processes).
- 4. If any conditions in (1) or condition 2 and 3 in (2) are not met, bake the components in accordance with the conditions at **125deg-C 24hours**
- 5. As a rule, baking the components in accordance with conditions 4 in (2) shall be once.
- Since semi-conductors are inside of the components, they must be free from static electricity while handled.(<100V) Use ESD protective floor mats, wrist straps, ESD protective footwear, air ionizers etc., if necessary.
- 7. Please make sure that there are lessen mechanical vibration and shock for this module, and do not drop it.
- 8. Please recognize pads of back side at surface mount.
- 9. Washing the module is not recommended. If washing cannot be avoided, please test module functionality and performance after thoroughly drying the module. We cannot be held responsible for any failure due washing the module..
- 10. Please perform temperature conditions of module at reflow within the limits of the following.

Please give the number of times of reflow as a maximum of 2 times.

Control No.		Control name
HQ-BA-537	(2/2)	Handling Precaution



TAIYO YUDEN CO., LTD.

Control No.		Control name
HD-BB-A160260	(1/3)	Packaging Specification

Packaging Specification

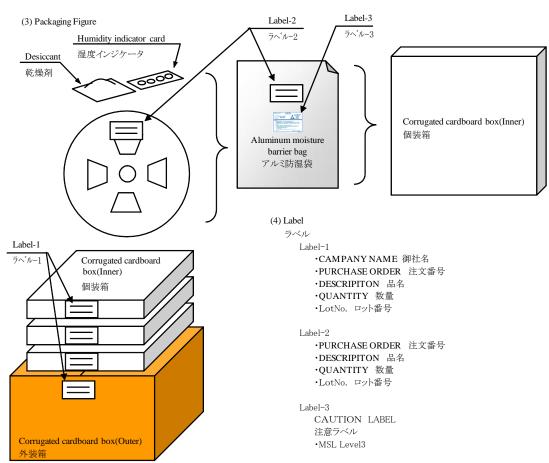
梱包仕様

也任体			
(1) Packaging Material 梱包材	才料		
Name	Outline	Materials	Note
部材名	概要	材質	備考
Emboss	24mm wide - 12mmPitch	Conductive PS	
エンボス	24mm幅 - 12mmピッチ	導電性 PS	
Cover Tape			
カバーテープ			
Reel	φ 330 mm	Conductive PS	
リール		導電性 PS	
Desiccant	$30g \times 1$		
乾燥剤			
Humidity indicator card			
湿度インジケータ			
Aluminum moisture barrier bag	420×460(mm)	(AS)PET/AL/NY/PE(AS)	
アルミ防湿袋			
Label			
ラベル			
Corrugated cardboard box(Inner)	$339 \times 351 \times 74 \text{(mm)}$		
個装箱			
Corrugated cardboard box(Outer)	$369\times369\times277(\text{mm})$		
外装箱			

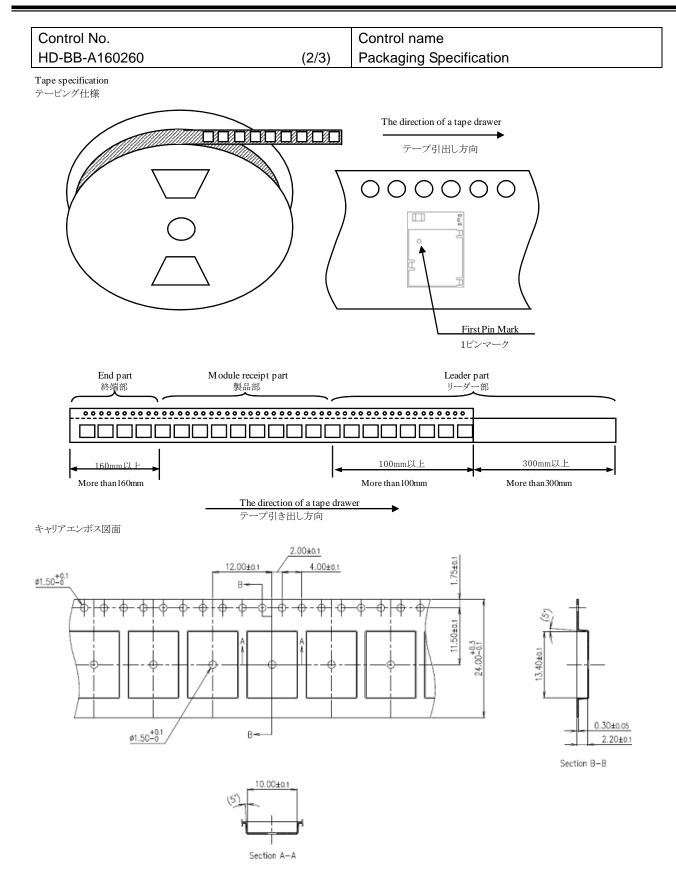
(2) Packaging Unit

梱包数量

Max 1000 pieces/Reel Max 3000 pieces/Box(Outer)



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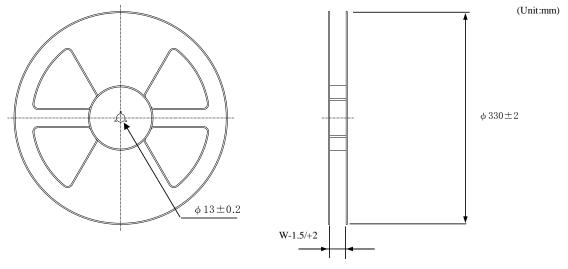
TAIYO YUDEN CO., LTD.

TAIYO YUDEN CO., LTD.

Control No.		Control name
HD-BB-A160260	(3/3)	Packaging Specification

Reel specification

リール仕様



Tape wide	8mm	12mm	16mm	24mm	32mm	44mm
W	9.4mm	13.4mm	17.4mm	25.4mm	33.4mm	45.4mm

Taping performance

テーピング性能

Both of an embossing tape top cover tape bear this, when the power of 10N is applied in the direction of a drawer.

・エンボステープ、トップカバーテープともに、引き出し方向に10Nの力を加えた場合に、これに耐えうること.

The exfoliation adhesion of a top cover tape is the intensity of 0.1 $\!\sim\!$ 1.3N.

(The angle to pull is 165 $\!\sim\!$ 180 degrees. The speed to pull is 300 mm/min.)

・トップカバーテープの剥離強度は、角度165~180度に保ち、300mm/minのスピードでトップカバーテープを引っ張ったとき、0.1~1.3Nとする.

Note

備考

Lack of the parts in 1 reel is with two or less pieces.

1リール中の部品の欠落は2個までとします。(ラベル表示数量と梱包数は同じです。欠落とはテープ内でのモジュール抜けが2個まで許容させていただくという意味になります。)

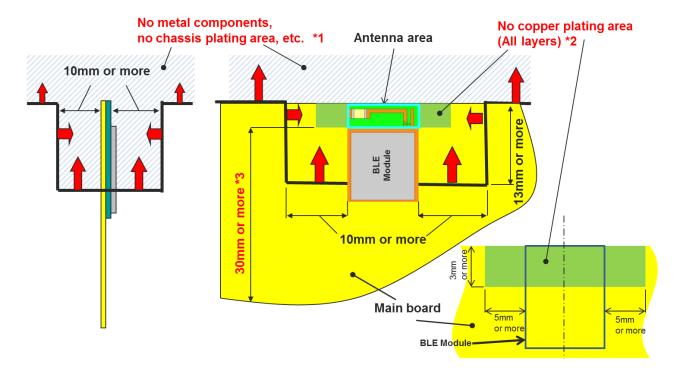
MSL Level 3 Under control

MSL はレベル3で管理しています。

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Control No.	Control name
(1/3)	Antenna application note

Recommended module mounting example



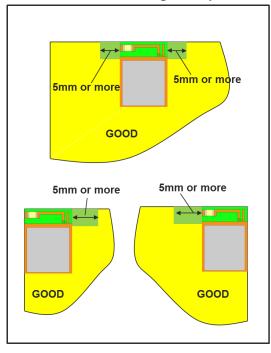
- *1 Please do not place any metal components in blue shaded space,(*1) such as signal line and metal chassis as possible except for main board while mounting the components in *1 space on the main board is allowed except for no copper plating area. (*2).
- *2 This area is routing prohibited area on the main board. Please do not place copper on any layer. Please remain use of FR-4 dielectric material. The antenna is tuned with the FR-4.
- *3 Characteristics may deteriorate when GND pattern length is less than 30mm. It should be 30 mm or more as possible.

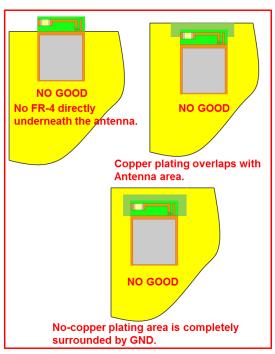
Even when above mentioned condition is satisfied, communication performance may be significantly deteriorated depending on the structure of the product.

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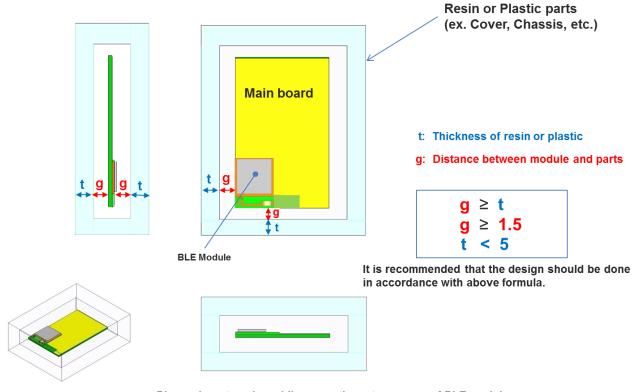
Control No.	Control name
(2/3)	Antenna application note

Other module mounting examples





Placement of resin or plastic parts

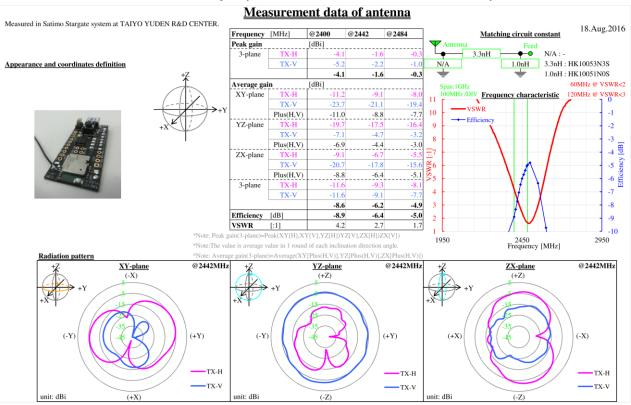


Please do not apply molding over the antenna area of BLE module.

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Control No.	Control name
(3/3)	Antenna application note

Directional characteristics example (when mounted on evaluation board)



About this Application Note

- •This Application Note has been prepared as a reference material to help obtaining the antenna performance mounted on BLE module better while it is not guaranteed or assured to obtain better communication performance and distance.
- •This product "BLE module" has been certified and matching circuit constant for antenna within module cannot be changed when ambient environment condition changes. The product must be re-certified when matching circuit constant is changed.

TAIYO YUDEN CO., LTD.

Control No.	Control name
(1/1)	Design guide

1. Power Up Sequence

VCC_NRF power supply rise time (0V to 1.7V) must not exceed 60ms.

2. Recommended Power Circuit

VCC_NRF is the main power supply (1.7 - 3.6V) for this module. The supply voltage range of VCC_NRF is 1.7V to 3.6V in both of LDO and DCDC mode. In case of the power supply voltage fluctuation by the load change is large, the module may not function properly. If an external regulator is used, the load change characteristic should be good in order to keep stable voltage as possible when the current is change.

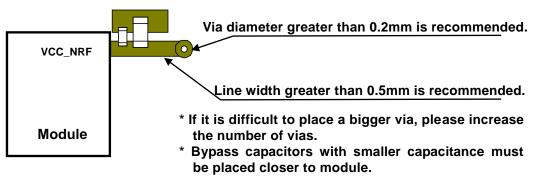
3. Battery operation

When using a small battery (e.g. CR2032), a large capacitor (e.g.100uF low leakage capacitor) should be placed near the battery. This will reduce the voltage drop especially when the module is operated at low temperatures

4. Pattern Design Guide

4-1. Power Supply System

Power supply bypass capacitors should be placed close to the VCC_NRF pin of the module. The VCC_NRF trace should be greater than 0.5mm and a bigger a via diameter is recommended.

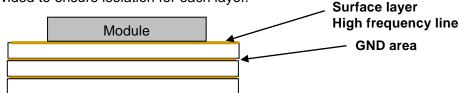


5.0. Bypass Capacitor Layout

A parallel combination of a small capacitance (about 10pF) and a large capacitance (1uF to 10uF) is recommended for bypass capacitors. The GND of the bypass capacitor must be placed close to an adjacent module GND to ensure the shortest closed loop.

4-3. GND Pattern

Power supply bypass capacitor GND should be placed in proximity of module GND. Wide GND area must be provided to ensure isolation for each layer.



GND pattern of each layer should be connected to GND area with large number of via.

その他、注意事項について (Precautions)

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- Please conduct validation and verification of our products in actual condition of mounting and operating environment before using our products.
- The products listed in this specification are intended for use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC). Please be sure to contact TAIYO YUDEN for further information before using the products for any equipment which may directly cause loss of human life or bodily injury (e.g., transportation equipment including, without limitation, automotive powertrain control system, train control system, and ship control system, traffic signal equipment, disaster prevention equipment, medical equipment classified as Class I, II or III by IMDRF, highly public information network equipment including, without limitation, telephone exchange, and base station).

Please do not incorporate our products into any equipment requiring high levels of safety and/or reliability (e.g., aerospace equipment, aviation equipment, medical equipment classified as Class IV by IMDRF, nuclear control equipment, undersea equipment, military equipment).

When our products are used even for high safety and/or reliability-required devices or circuits of general electronic equipment, it is strongly recommended to perform a thorough safety evaluation prior to use of our products and to install a protection circuit as necessary.

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this specification for any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

- Information contained in this specification is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.
- Please note that the scope of warranty for our products is limited to the delivered our products themselves and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a fault or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such agreement.

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- The contents of this specification are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this specification are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.
- Caution for Export

Some of our products listed in this specification may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

Mouser Electronics

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